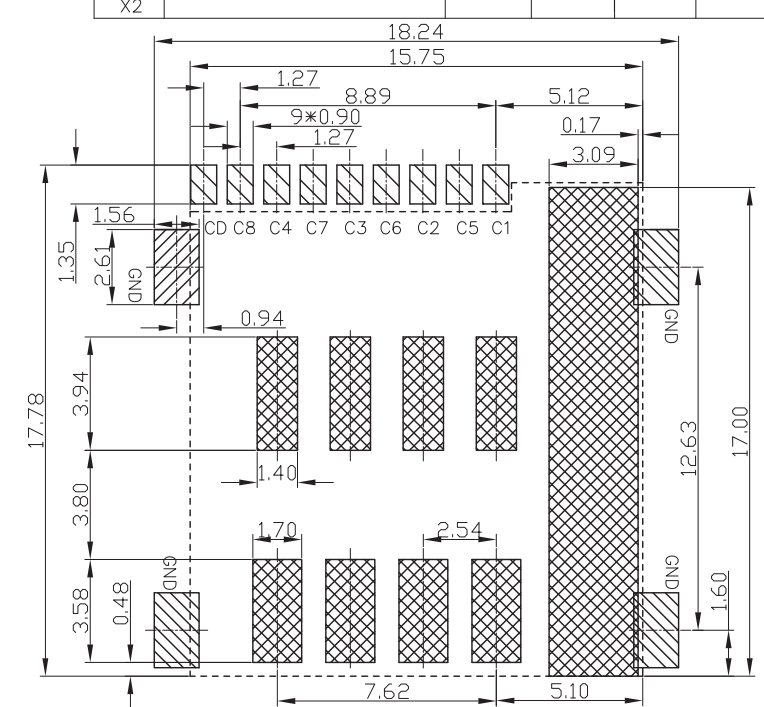
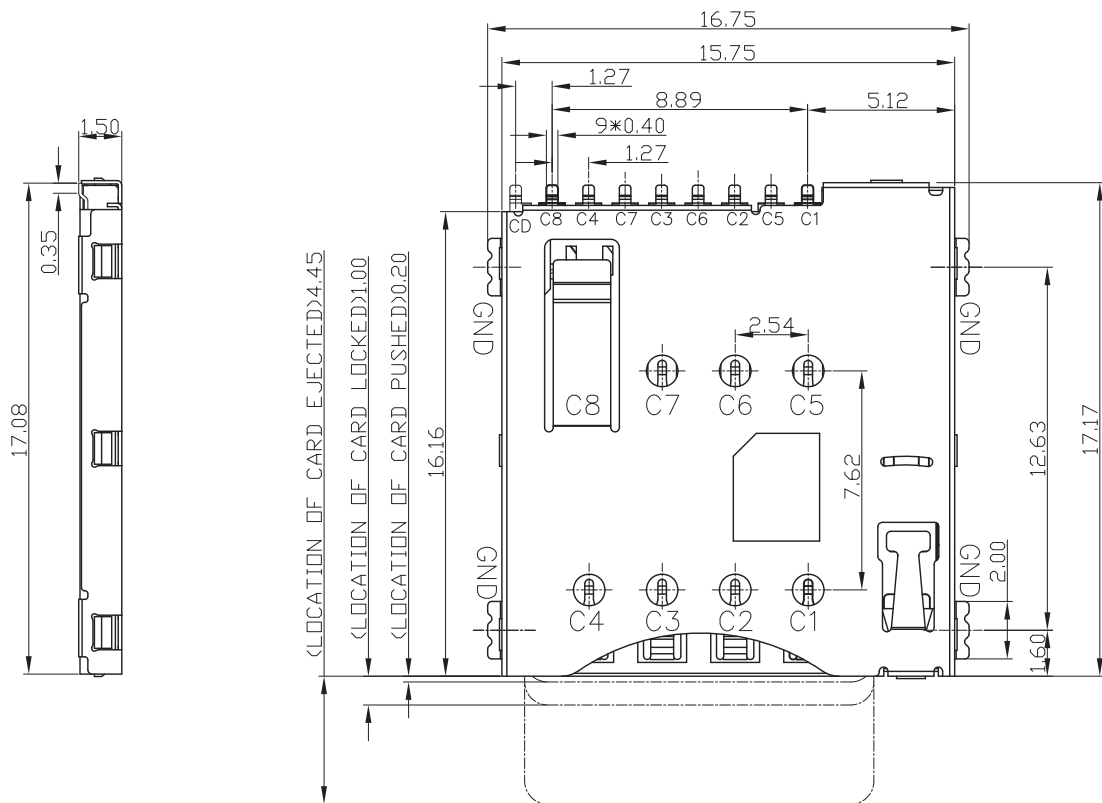


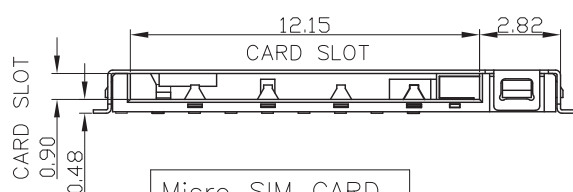
REV.	DESCRIPTION OF REVISIONS	APPR.	DRAW.	RELEASE	DATE
X1					
X2					



PAD AREA
 KEEP OUT AREA
 RECOMMENDED P.C.B LAYOUT
 COMPONENT SIDE(TOLERANCE ±0.05)

TECHNICAL CHARACTERISTICS

- General Characteristics**
 Dimensions: 15.75LX17.17WX1.50H mm
 Weight: Approx 0.4±0.1g
 Durability: 1500 cycles min.
- Electrical Characteristics**
 Contact resistance;
 Date Contact: 150mΩ max
 CD Switch: 500mΩ max
 Insulation resistance: >1000MΩ/500V DC
- Solderability**
 Vapor phase: 215°C, 30sec.Max
 IR reflow: 250°C, 5sec.Max
 Manual soldering: 370°C, 3sec.Max
- Environmental Characteristics**
 Operating temperature: -40°C~+85°C
 Operating humidity: 10%~+95%RH



Micro SIM CARD	
Pin No.	NAME
C1	VCC
C2	RST
C3	CLK
C4	Reserved
C5	GND
C6	VPP
C7	I/O
C8	Reserved

ELECTRIC FUNCTION	DETECT SWITCH
WITHOUT CARD	CLOSED
CARD INSERTED	OPEN



ITEM	PART NAME	Q'TY	MATERIAL	FINISH
1	HOUSING	1	Hi-temp Thermoplastic	Black UL94V-0
2	DATA CONTACT	6	Copper Alloy	Contact area:Gold plated
3	CD SWITCH	1	Copper Alloy	Contact area:Gold plated
4	SHELL	1	Stainless Steel	SMT area:Gold plated
5	COIL SPRING	1	SWP	
6	HEART CAM	1	Hi-temp Thermoplastic	Black UL94V-0
7	CAM PIN	1	Stainless Steel	

Unless otherwise specified, other tolerance are:

Wellco T&C Co., Ltd.

X ±0.35	X' ±5'	NAME: MicroSIM Card Connector	
X.X ±0.25	X.X' ±4'	MODEL NO: 792-8Pin	
X.XX ±0.15	X.XX' ±3'	TYPE: Normally CLOSE H1.50 8PIN	
X.XXX ±0.10	X.XXX' ±2'		
PROJ.	UNIT mm	SCALE 1:1	DWG NO.: 792-001
CUSTOMER DRAWING			SHEET 1/1
			REVISION X1